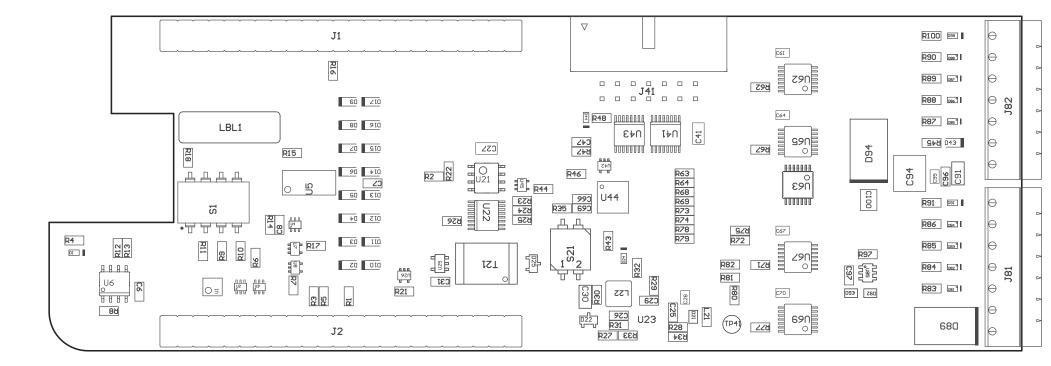
ZZ1 Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.

ZZ2 ■ This Assembly Note will show in the PcbDoc and associated outputs

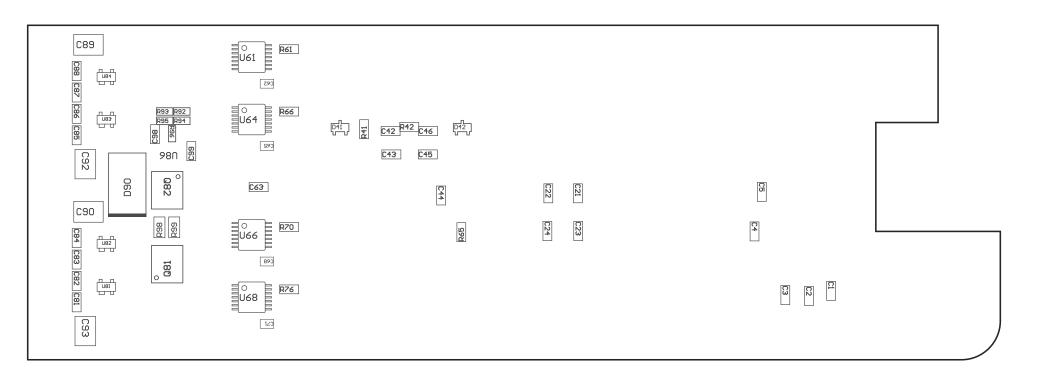
ZZ3 ■ This Assembly Note will show in the PcbDoc and associated outputs

ZZ4 ■ This Assembly Note will show in the PcbDoc and associated outputs



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00183	REV: E1	SUN REV	: Not In VersionControl
IGNORE ->				
PLOT NAME = Top Assembly Drawing	GENERATED : 6/12/2	2015 5:03:36	PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00183	REV: E1	SUN REV	: Not In VersionControl		
	IGNORE ->					
PLOT NAME = Bottom Assembly Drawing	GENERATED : 6/12/2	2015 5: 03: 44	PM	TEXAS INSTRUMENTS		

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